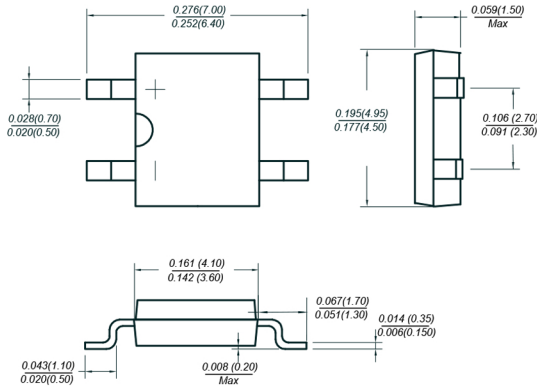


MBF



Dimensions in inches and (millimeters)

FEATURES

- ◆ Ideal for printed circuit board
- ◆ Reliable low cost construction utilizing molded plastic technique
- ◆ High temperature soldering guaranteed: 260°C/10 seconds at 5 lbs., (2.3kg) tension
- ◆ Small size, simple installation
- ◆ High surge current capability
- ◆ Glass passivated chip junction
- ◆ Green compound(halogen&Sb₂O₃ free)

MECHANICAL DATA

Case: Molded plastic body
Terminals: Plated leads solderable per MIL-STD-750, Method 2026
Polarity: Polarity symbols marked on case
Mounting Position: Any

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.
 Single phase half-wave 60Hz, resistive or inductive load, for capacitive load derate current by 20%.

	SYMBOLS	MB2F	MB4F	MB6F	MB8F	MB10F	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	200	400	600	800	1000	V
Maximum average forward rectified current On glass-epoxy P.C.B. (Note1) On aluminum substrate (Note2)	I _{F(AV)}	0.6 1.0					A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	30					A
Maximum instantaneous forward voltage drop per leg at 0.4A	V _F	1.0					V
Maximum DC reverse current at rated DC blocking voltage T _A =25°C T _A =125°C	I _R	5.0 500					uA uA
Typical junction capacitance per leg(Note3)	C _J	13					pF
Typical thermal resistance per leg	R(θ) _{JA}	88					°C/W
Operating temperature range	T _J	-55 to +150					°C
storage temperature range	T _{STG}	-55 to +150					°C

NOTES: 1. On glass epoxy P.C.B. mounted on 0.05x0.05"(1.3x1.3mm) pads
 2. On aluminum substrate P.C.B. with an area of 0.8"x0.8"(20x20mm) mounted on 0.05X0.05"(1.3X1.3mm) solder pad
 3. Measured at 1.0MHz and applied reverse voltage of 4.0 volts.

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT FOR

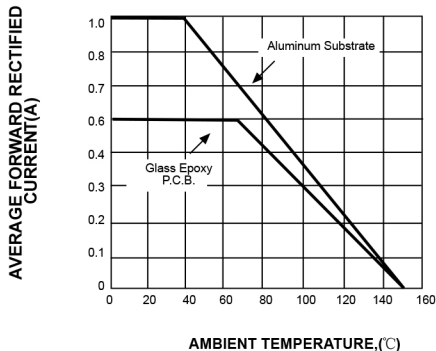


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

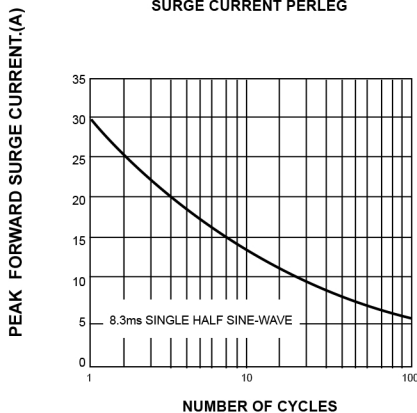


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS PER LEG

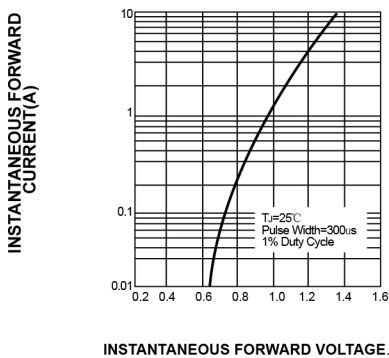


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS PER LEG

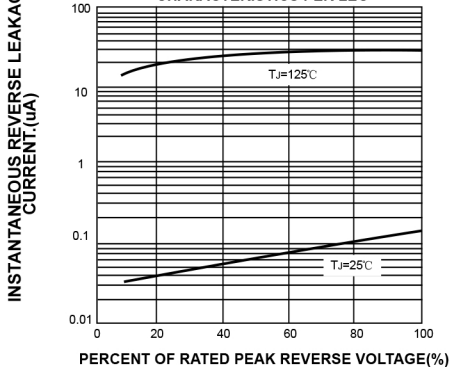
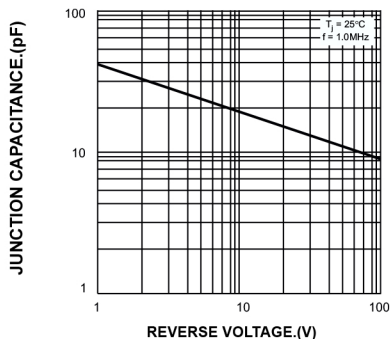


FIG. 5-TYPICAL JUNCTION CAPACITANCE PER LEG



单击下面可查看定价，库存，交付和生命周期等信息

[>>RCD\(达标电子\)](#)